

09-22-2008

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Docket No.: 075905-0055 103525	5926	
To the Director of the U.S. Patent and Trademark Office: Please	record the attached documents or the new address(es) below.	
1. Name of Conveying Party(ies)	2. Name and address of receiving party(ies)	
Takeshi SUNAONHI, Kouichi KUROSAWA, Takeshi SATO,	Name: HITACHI HIGH-TECHNOLOGIES	
Masaaki KOMORI	CORPORATION	
	Internal Address:	
Additional name(s) o conveying party(ies) attached? Yes No		
3. Nature of Convey ance/Execution Date(s)	Address: 12-24-14, Nishi Shinbashi, Minato-ku Tokyo	
5. Ivature of Convey ances Execution Date(5)	JAPAN	
Describing Data(a). Assumed 4 2000	UALAN	
Execution Date(s): August 4, 2008		
Assignment Merger		
Security Agreement Change of Name		
☐ Joint Research Agreement		
Government Interest Assignment		
Executive Order 9424, Confirmatory License		
Other	Additional name(s) & address(es) attached? Yes No	
4. Application or patent number(s):	This document is being filed together with a new application.	
A. Patent Application No(s).	B. Patent No(s).	
12/146,029		
Additional numbers attached? Yes No		
5. Name and address to whom correspondence concerning	6. Total number of applications and patents	
document should be mailed:	involved:	
Name: MCDERNOTT WILL & EMERY LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00	
Internal Address:	Authorized to be charged by credit card	
mornal radios.	Authorized to be charged to deposit account	
Street Address: 600 13th Street, N.W.	Enclosed	
Street Address: 600 13th Street, N.W.	None required (government interest not affecting title)	
Washington State: D.C. Zip: 20005-3096		
City: Washington State. B. C.	8. Payment Information:	
Phone Number: 2(2.756.8000	0. 2 4.)	
Fax Number: 20.2.756.8087	a. Credit Card Last 4 Numbers	
Email Address:	Expiration Date	
	b Deposit Account Number 500417	
	Authorized User Name	
	91 Fer 8021 40.00 DA September 17, 2008	
9. Signature.	Date	
Keith E. George 34,111	Signature 2	
Name and Registration No. of Person Signing Total number of pages inclu	ding cover sheet, attachments and documents: 2	
TOTAL TOTAL		

PATENT REEL: 021575 FRAME: 0530

ASSIGNMENT (譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan,

located at 1-24-14, Nishi Shinbashi, Minato-ku, Tokyo, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said. Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

INSPECTION APPARATUS AND METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi High-Technologies Corporation,

INDICATE OF (O)

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

RECORDED: 09/17/2008

	(発明者フルネームサイン)	(署名日)
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2)	Kouchi Kurosuwa	8/4/2008
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4)	Masaaki Komori	\$/4/2008
5)		
6)		
7)		
8)		
9)		_
10)		

PATENT REEL: 021575 FRAME: 0531

Data Signed